L Number	Hits	Search Text	DB	Time stamp
1	4	(385/\$).ccls. and optoelectronic and (compression near3	USPAT;	2003/10/03 12:17
		molding) and encapsulat\$	US-PGPUB;	
İ			EPO; JPO	ļ
2	8	(385/\$).ccls. and optoelectronic and (compression near3	USPAT;	2003/10/03 12:17
1		molding)	US-PGPUB;	Ì
ļ			EPO; JPO	
3	95	((optic\$ or optoelectronic) near5 device) and substrate and	USPAT;	2003/10/03 12:18
		(compres\$ near4 mold\$) and (curable or curing or epoxy or	US-PGPUB;	
		plastic or fluid or polymer) and (capsul\$ or encapsulat\$)	EPO; JPO	
4	425	optical and device and substrate and (compres\$ near4	USPAT;	2003/10/03 12:26
		mold\$) and (curable or curing or epoxy or plastic or fluid or	US-PGPUB;)
i		polymer) and (capsul\$ or encapsulat\$)	EPO; JPO	2000/10/02 12 00
5	99	optical and device and substrate and (curable or curing or	USPAT;	2003/10/03 12:28
		epoxy or plastic or fluid or polymer) and (capsul\$ or	US-PGPUB;	
ļ		encapsulat\$) and ((mold or molding or shape or shaping)	EPO; JPO	t
_		near5 tool) and (fiber or waveguide)	İ	0000/40/00 40 00
6	135	(385/94).ccls. and (mold\$ or shape or shaping) and (curable	USPAT;	2003/10/03 12:29
i		or curing or epoxy or plastic or fluid or polymer)	US-PGPUB;	1
_ }	_	(205/00.00.00)	EPO; JPO	2002/40/22 42 22
7	5	(385/88,89,94).ccls. and optical and device and substrate	USPAT;	2003/10/03 12:32
ĺ		and (curable or curing or epoxy or plastic or fluid or	US-PGPUB;	
i		polymer) and (capsul\$ or encapsulat\$) and ((mold or	EPO; JPO	ļ
		molding or shape or shaping) near5 tool) and (fiber or		
	2	waveguide)	LICDAT	1 2002/40/02 42:22
8	2	((385/88,89,94).ccls. or (372/50).ccls.) and optical and	USPAT;	2003/10/03 12:33
!		device and (curable or curing) and (epoxy or plastic or resin	US-PGPUB;	
		or polymer) and (fluid or gel) and (capsul\$ or encapsulat\$)	EPO; JPO	
i		and ((mold or molding or shape or shaping) near5 tool) and	1	ļ
0	4	(fiber or waveguide)	LICDAT	2003/10/03 12:33
9	4	((385/88,89,94).ccls. or (372/50).ccls.) and optical and	USPAT;	2003/10/03 12.33
Ì		device and (curable or curing) and (epoxy or plastic or resin	US-PGPUB; EPO; JPO	} I
į		or polymer) and (fluid or gel) and (capsul\$ or encapsulat\$)	EPO, JPO	
10	12	and (mold or molding or shape or shaping) and vcsel ((385/88,89,94).ccls. or (372/50).ccls.) and optical and	USPAT;	2003/10/03 12:33
10	12	device and (curable or curing) and (epoxy or plastic or resin	US-PGPUB;	2003/10/03 12.33
ĺ			EPO; JPO	
		or polymer) and (fluid or gel) and (capsul\$ or encapsulat\$) and (mold or molding or shape or shaping)		
11	39	((385/88,89,94).ccls. or (372/50).ccls.) and optical and	USPAT;	2003/10/03 12:34
	39	device and (curable or curing) and (epoxy or plastic or resin	US-PGPUB;	2003/10/03 12.34
; 		or fluid or gel) and (capsul\$ or encapsulat\$) and (mold or	EPO; JPO	
Į.		molding or shape or shaping)	2. 5, 5, 5	İ
12	7	device and encapsulats and (cure or curable or curing) and	EPO; JPO	2003/10/03 12:35
12	,	optical	1 2, 3, 3, 3	
13	36	device and encapsulat\$ and (cure or curable or curing) and	DERWENT	2003/10/03 12:35
10	50	optical		
14	63	device and (shap\$ near4 encapsulat\$) and (cure or curable	USPAT;	2003/10/03 12:36
1	0.5	or curing) and optical	US-PGPUB	1213, 20, 03 12.30
15	253	device and (mold\$ near4 encapsulat\$) and (cure or curable	USPAT;	2003/10/03 12:38
	200	or curing) and optical	US-PGPUB	
16	246	device and (mold\$ near4 encapsulat\$) and (cure or curable	USPAT;	2003/10/03 14:02
	2.10	or curing) and optical and (gel or epoxy or adhesive or fluid	US-PGPUB	
I I		or polymer)	; == . =. 33	j
17	350	((optic or optical or optoelectronic) near4 device) and	USPAT;	2003/10/03 14:12
	330	((shap\$ or mold\$) near4 (gel or resin or adhesive or epoxy	US-PGPUB	
1		or polymer or fluid)) and (cure or curable or curing) and	20.0.00	1
ĺ		encapsulat\$	1	İ
18	15	(compression near4 molding) and (cure or curing or curable)	USPAT;	2003/10/03 14:23
	13	and encapsula\$ and optoelectronic and fiber	US-PGPUB;	,,
		and onespecial and opening and more	EPO; JPO	I

19	21	(compression near4 molding) and (cure or curing or curable)	USPAT;	2003/10/03 14:24
1	ĺ	and encapsula\$ and (optic\$ near5 electronic) and fiber	US-PGPUB;	j
	i		EPO; JPO	
20	5	(385/94).ccls. and (mold\$ or shape or shaping) and (curable	USPAT;	2003/10/03 14:24
i		or curing or epoxy or plastic or fluid or polymer) and	US-PGPUB;	
		(capsul\$ or encapsulat\$) and tool	EPO; JPO	
21	37	(385/94).ccls. and (mold\$ or shape or shaping) and (curable	USPAT;	2003/10/03 14:25
		or curing or epoxy or plastic or fluid or polymer) and	US-PGPUB;	
		(capsul\$ or encapsulat\$)	EPO; JPO	